## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1.	7	pettern with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:32
S2	83061	deposit\$4 with material with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:32
S3	281779	(pattern conductor trace pad) with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08:23:35
\$4 !	1167	(pattern conductor trace pad) with imprint\$4 with material	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:36
S5	1191168	(pattern conductor trace pad layer film) with substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:35
S6	2273	(pattern conductor trace pad layer film) with imprint\$4 with material	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:36
S7	477219	material with (stamp\$4 or mold\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:37
\$8 :	390628	material with (polymer or photo-resist or resist)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:38

## **EAST Search History**

\$9	971110	(material or (polymer or photo-resist or resist)) with (remov\$4 etch\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08 23:39
S10	92	S2 and S4 and S5 and S6 and S7 and S9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/08:23:41
S11	24	@ad <= "20030409" and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/09 22:39
\$12 -	2	"20010055854"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/09 22:40
S13	2	"20020131682"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/07/09 22:40

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